UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/702,416	11/06/2003	Daniel C. Edelstein	FIS920030260 US1	8350	
29505 7590 06/21/2007 LAW OFFICE OF DELIO & PETERSON, LLC. 121 WHITNEY AVENUE			EXAM	EXAMINER	
			ABOAGYE, MICHAEL		
NEW HAVEN, CT 06510			ART UNIT	PAPER NUMBER	
•					
		•			
	•		.MAIL DATE	DELIVERY MODE	
•		•	06/21/2007	PAPER	

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)		
* .	10/702,416	EDELSTEIN ET AL.		
Office Action Summary	Examiner	Art Unit		
	Michael Aboagye	1725		
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the o	correspondence address		
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period versilled to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).		
Status				
Responsive to communication(s) filed on <u>28 M</u> This action is <b>FINAL</b> . 2b) ☐ This     Since this application is in condition for allowar closed in accordance with the practice under E	action is non-final.  nce except for formal matters, pro			
Disposition of Claims				
4) ☐ Claim(s) 1-5 and 21 is/are pending in the application 4a) Of the above claim(s) is/are withdraw 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-5 and 21 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or	wn from consideration.			
Application Papers				
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) accomplicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Example 11.	epted or b) objected to by the drawing(s) be held in abeyance. Se ion is required if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).		
Priority under 35 U.S.C. § 119				
<ul> <li>12) Acknowledgment is made of a claim for foreign</li> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents</li> <li>2. Certified copies of the priority documents</li> <li>3. Copies of the certified copies of the priority application from the International Bureau</li> <li>* See the attached detailed Office action for a list</li> </ul>	s have been received. s have been received in Applicati rity documents have been receive u (PCT Rule 17.2(a)).	ion No ed in this National Stage		
•				
Attachment(s)	4) Interview Summary	(PTO 413)		
<ol> <li>Notice of References Cited (PTO-892)</li> <li>Notice of Draftsperson's Patent Drawing Review (PTO-948)</li> <li>Information Disclosure Statement(s) (PTO/SB/08)</li> <li>Paper No(s)/Mail Date</li> </ol>	4)	ate		

Art Unit: 1725

#### **DETAILED ACTION**

### Claim Rejections - 35 USC § 112

- 1. The following is a quotation of the second paragraph of 35 U.S.C. 112:

  The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 2. Claims 1-5 and 21 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention. Claim 1 recites the limitation "said apparatus" in line 2. There is insufficient antecedent basis for this limitation in the claim.

## Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 1-5 and 21 are rejected under 35 U.S.C. 103(a) as being unpatentable over Chittipeddi et al. (US Patent No. 6,472,304) in view of Sakane et al. (JP 56-017048).

Regarding claims 1-5 and 21, Chittipeddi et al. teaches structure formed by bonding an integrated circuit to a substrate comprising: a substrate ("11", figure 1) a gold wire ("61", figure 20) a copper interconnect ("13", figure 1 or "44", figure 21) within said substrate (abstract) and an alloying metal deposited on said metallic interconnect ("74", figure 21), (abstract; column 3, lines 44- 67 and column 4, lines 3-12). The

Art Unit: 1725

intended operating conditions are noted, however, said intended operating conditions do not patentably distinguish said claimed invention over the prior art.

Chittipeddi et al. does not expressly teach forming a low temperature alloy material including Au-Sn or Au-In between the gold wire and the alloy metal.

However, Sakane et al. teaches a semi conductor assembly having, a metallic alloy of Ni-Sn formed on the surface of a substrate; a gold wire bonded by thermocompression to the Ni-Sn layer allowing a low temperature alloy of Au-Sn to be formed between the gold wire and the Sn of the alloy material layer, wherein said alloy prevents migration of species across the interconnect, reduces the risk of joint deterioration and thereby improving the integrity of the bonding process (Sakane et al. abstract). Note the Sn in the Au-Sn eutectic provides the lowering melting point; hence the limitations recited in claim 4 are met.

It would have been obvious to one of ordinary skill in the art at the time the applicant's invention was made to deposit Ni –Sn on the copper interconnect of Chittipeddi et al. as taught by Sakane et al. to enable the formation of Au-Sn alloy which prevents migration of species across the interconnect, reduce the risk of joint deterioration and thereby improving the integrity of the bonding process (Sakane et al. abstract).

# Response to Arguments

5. The examiner acknowledges the applicants' amendment received by USPTO on March 23, 2007. Claims 1-5 and 21 remain under consideration in the application.

Art Unit: 1725

6. Applicant's arguments filed March 23, 2007 have been fully considered but they are not persuasive. In response to the applicant's argument that it is improper to combine the inventions of Chitipeddi et al. and Sakena et al., It is noted that both references teach thermocompression bonding with a gold wire onto a metallized surface, and depositing a barrier layer which prevents migration of the metallic species forming the metallization. The deficiency of Chittipeddi et al. is drawn to applying a barrier layer, which forms an alloy with the gold wire. Sakena et al. teaches applying a nickel—tin alloy as a barrier layer on the metallized surface with the result that a gold-tin alloy is formed between the gold from the wire and the tin from the alloy deposited which prevents migration of the species forming the metallized surface. The examiner believes that Sakena et al. provides the remedy for the deficiencies of Chittipeddi et al. and that modification of the invention of Chittipeddi et al. in view of the teachings of Sakena et al. meets the applicant's claim invention.

Regarding the applicant's argument that Sakena et al. does not teach bonding an integrated chip to a semiconductor substrate, the examiner's position is that Chittipeddi et al. satisfies these limitations. It is also noted that the features upon which the applicant relies (i.e. an alloying metal deposited on said metallic interconnect or metallized surface said alloying metal comprising alloying metals other than said metallic wire material; and a resultant alloy material formed between said interconnect and said metallic wire) are taught by Sakena et al. Finally, it is noted that the references cannot be considered individually in showing nonobviousness where the rejections are based on combinations of references. See In re Keller, 642 F.2d 413, 208 USPQ 871 (CCPA 1981); In re Merck & Co., 800 F.2d 1091,231 USPQ 375 (Fed. Cir. 1986).

#### Conclusion

7. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

8. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Michael Aboagye whose telephone number is 571-272-8165. The examiner can normally be reached on Mon - Fri 8:30am - 5pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Patrick Ryan can be reached on 571-272-1292. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Art Unit: 1725

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

JONATHAN JOHNSON PRIMARY EXAMINER

Michael Aboagye Assistant Examiner Art unit 1725

06/14/2007

**₽**∕⁄\ MA